Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

CPC1125N
Single-Pole, Normally Closed 4-Pin SOP OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	400	V_P
Load Current	100	mA
Max On-Resistance	35	Ω
LED Current to Operate	2	mA

Features
- 1500V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 4-Pin SOP Package
- Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications
- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - Modem Switching (Laptop, Notebook, Pocket Size)
  - Hook Switch
  - Dial Pulsing
  - Ground Start
  - Ringing Injection
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description
CPC1125N is a miniature single-pole, normally closed (1-Form-B) solid state relay. It uses Clare's patented, optically coupled, OptoMOS architecture to provide 1500V_{rms} of input/output isolation in a small 4-Pin SOP package.

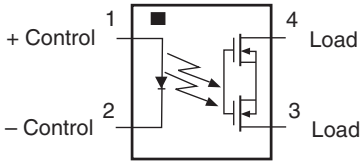
CPC1125N uses Clare's state of the art double-molded vertical construction packaging to produce one of the world's smallest relays. It is ideal for replacing larger, less-reliable reed and electromechanical relays.

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- Certified to:
  IEC60950-1: 2005
  EN60950-1: 2006
  TUV Certificate: B 09 07 49410 006

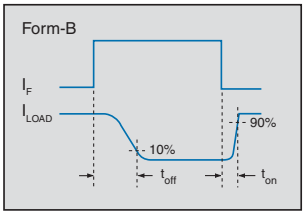
Ordering Information

Part #	Description
CPC1125N	4-Pin SOP (100/tube)
CPC1125NTR	4-Pin SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Closed Devices



Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Blocking Voltage	400	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	150	mW
Total Power Dissipation [1]	400	mW
Isolation Voltage, Input to Output	1500	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

[1] Derate linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

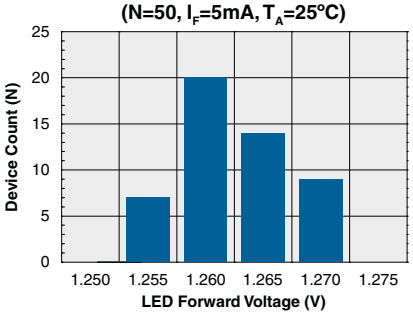
Electrical Characteristics @ 25ºC

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous [1]	I_F=0mA	I_L	-	-	±100	mA
Peak	t =10ms	I_{LPK}	-	-	±350	
On-Resistance [2]	I_L=100mA	R_{ON}	-	26	35	Ω
Switching Speeds						
Turn-On	I_F=5mA, V_L=10V	t_{on}	-	0.31	2	ms
Turn-Off		t_{off}	-	0.30	2	
Off-State Leakage Current	V_L=400V, I_F=2mA	I_{LEAK}	-	-	1	µA
Output Capacitance	I_F=2mA, V_L= 50V, f=1MHz	C_{OUT}	-	6	-	pF
Input Characteristics						
Input Control Current [3]	I_L=100mA	I_F	-	-	2	mA
Input Dropout Current	-	I_F	0.1	-	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.4	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Capacitance, Input to Output	-	$C_{I/O}$	-	1	-	pF

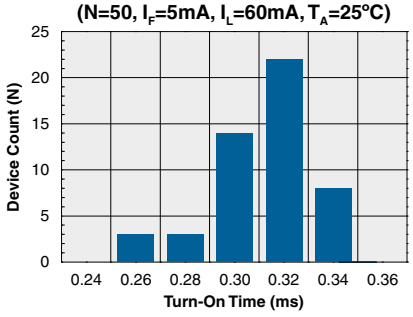
[1] Load current derates linearly from 100mA @ 25ºC to 60mA @ 85ºC.
[2] Measurement taken within 1 second of on-time.
[3] For applications requiring high temperature operation (greater than 60°C) a LED drive current of 4mA is recommended.

PERFORMANCE DATA*

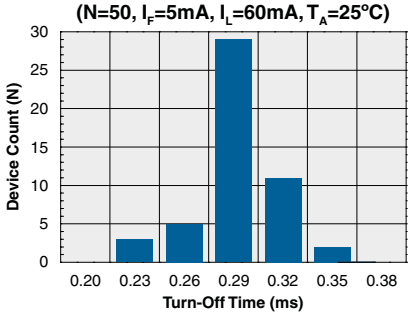
Typical LED Forward Voltage Drop
(N=50, I_F=5mA, T_A=25°C)



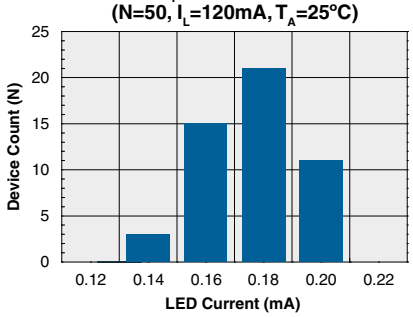
Typical Turn-On Time
(N=50, I_F=5mA, I_L=60mA, T_A=25°C)



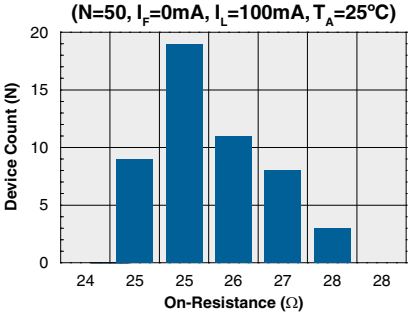
Typical Turn-Off Time
(N=50, I_F=5mA, I_L=60mA, T_A=25°C)



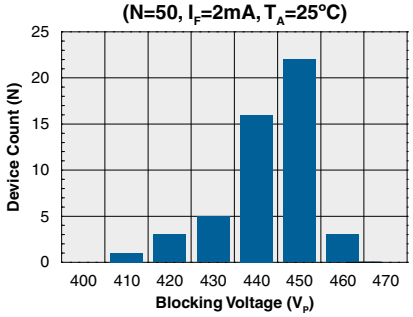
Form-B I_F for Switch Operation
(N=50, I_L=120mA, T_A=25°C)



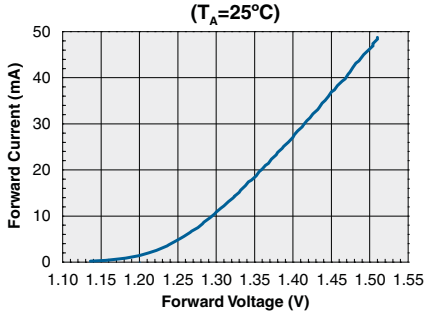
Typical On-Resistance Distribution
(N=50, I_F=0mA, I_L=100mA, T_A=25°C)



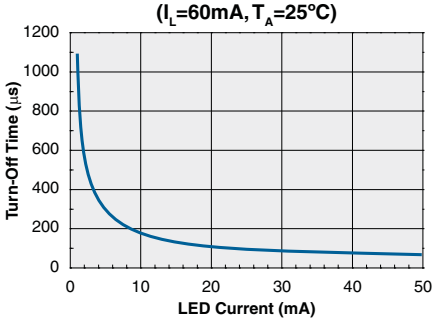
Typical Blocking Voltage Distribution
(N=50, I_F=2mA, T_A=25°C)



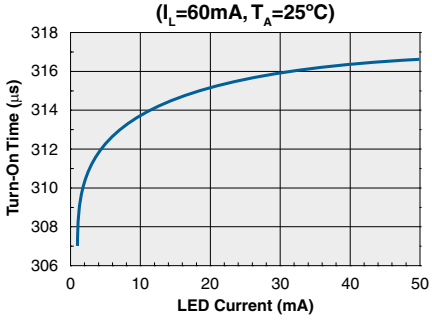
Typical LED Forward Voltage
vs. Forward Current
(T_A=25°C)



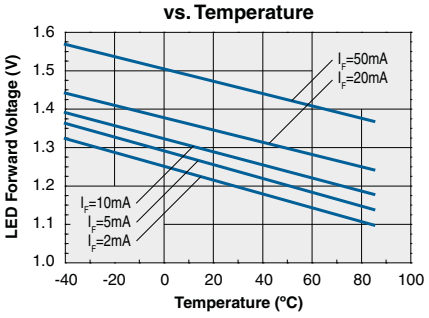
Typical Turn-Off Time
vs. LED Forward Current
(I_L=60mA, T_A=25°C)



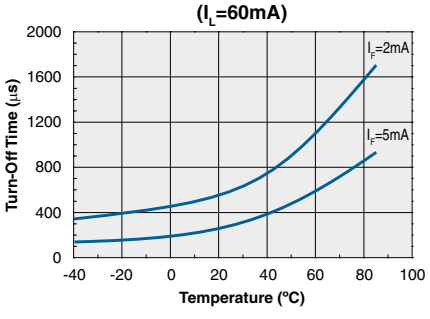
Typical Turn-On Time
vs. LED Forward Current
(I_L=60mA, T_A=25°C)



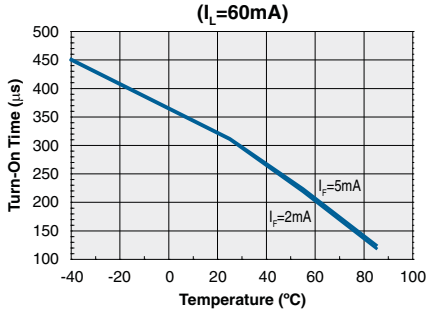
Typical LED Forward Voltage Drop
vs. Temperature



Typical Turn-Off Time
vs. Temperature
(I_L=60mA)



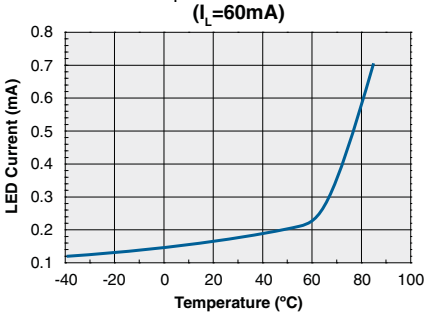
Typical Turn-On Time
vs. Temperature
(I_L=60mA)



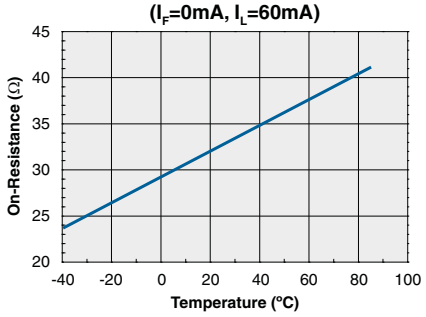
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

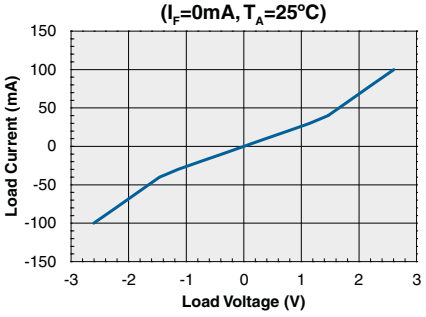
Typical I_F for Switch Operation (I_L=60mA)



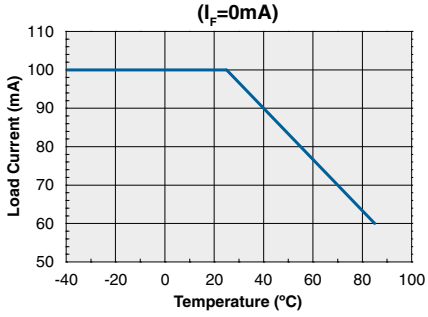
Typical On-Resistance vs. Temperature (I_F=0mA, I_L=60mA)



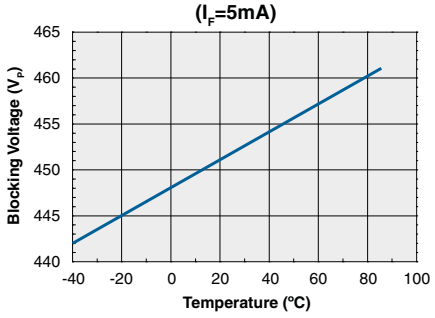
Typical Load Current vs. Load Voltage (I_F=0mA, T_A=25°C)



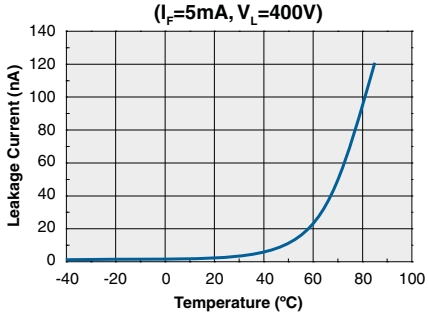
Maximum Load Current vs. Temperature (I_F=0mA)



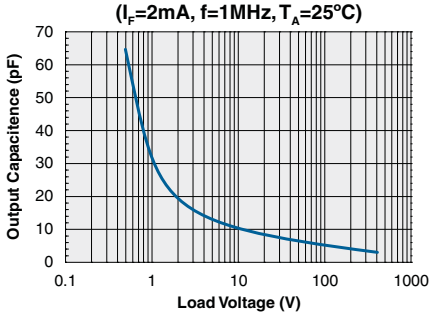
Typical Blocking Voltage vs. Temperature (I_F=5mA)



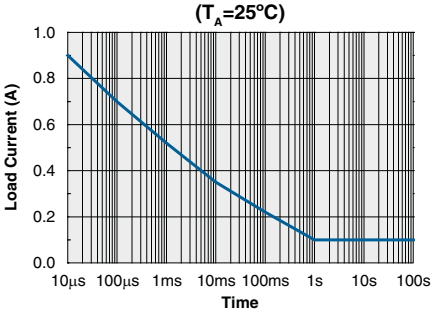
Leakage Current vs. Temperature Measured Between Pins 3&4 (I_F=5mA, V_L=400V)



Output Capacitance vs. Load Voltage (I_F=2mA, f=1MHz, T_A=25°C)



Energy Rating Curve (T_A=25°C)



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1125N	MSL 3

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

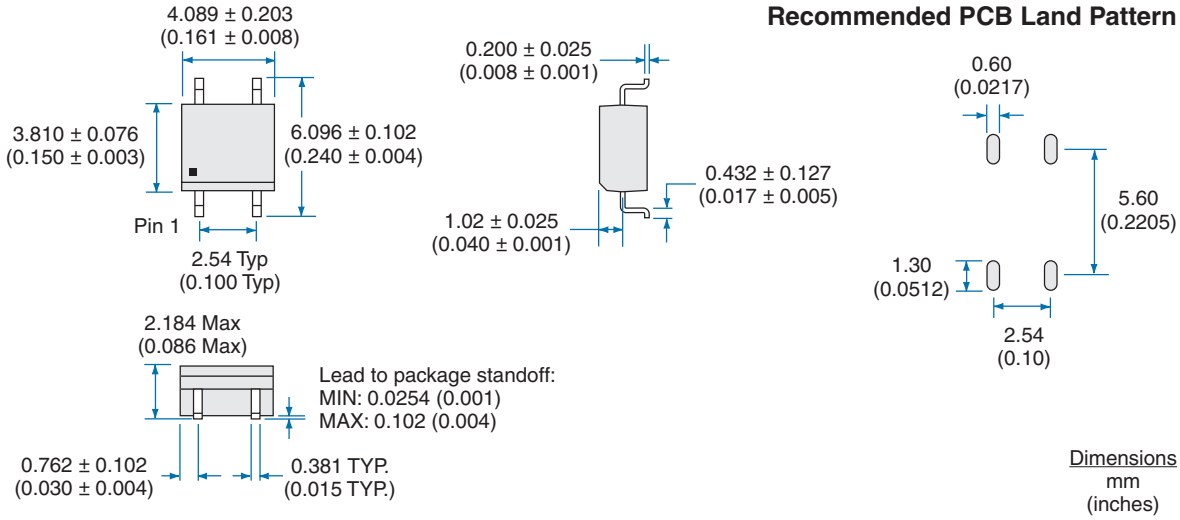
Device	Maximum Temperature x Time
CPC1125N	260°C for 30 seconds

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

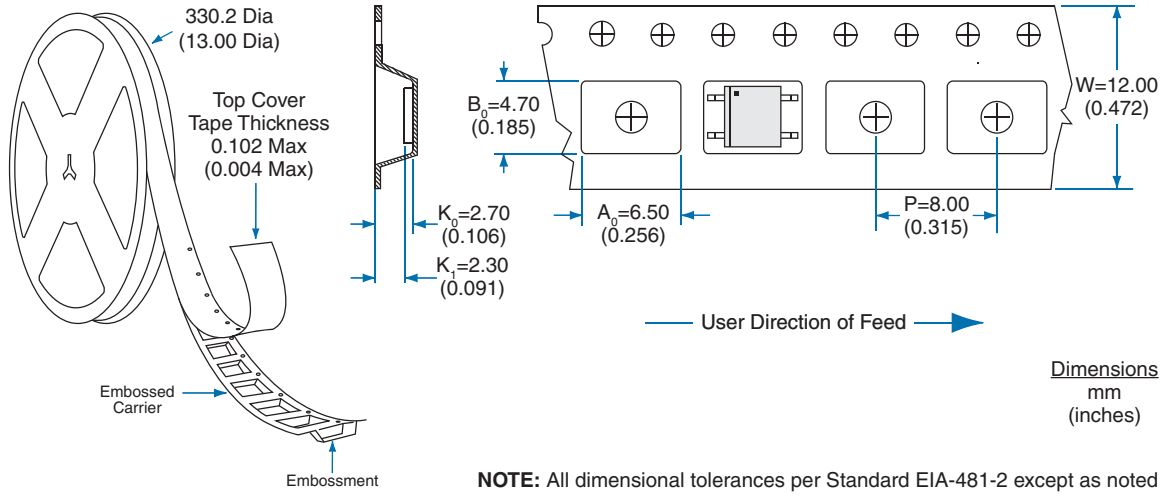
MECHANICAL DIMENSIONS

CPC1125N



Dimensions
mm
(inches)

CPC1125N Tape & Reel



Dimensions
mm
(inches)

NOTE: All dimensional tolerances per Standard EIA-481-2 except as noted

For additional information please visit our website at: www.clare.com

Specification: DS-CPC1125N-R01

8/10/2011